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<u>MOSFET</u> – Power, Single N-Channel 40 V, 1.0 mΩ, 277 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C420NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	40	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	۱ _D	277	А
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		196	
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_{C} = 25^{\circ}C$	PD	146	W
		T _C = 100°C		73	
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	۱ _D	45	А
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		32	
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.8	W
$R_{\theta JA}$ (Notes 1, 2)		$T_A = 100^{\circ}C$		1.9	
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	900	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	121.4	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 24 A)			E _{AS}	1541	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

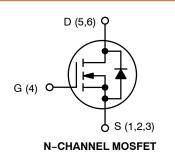
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.0	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

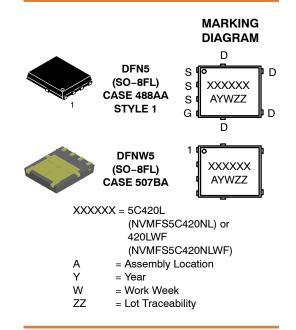
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	1.0 m Ω @ 10 V	277 A
40 V	1.4 mΩ @ 4.5 V	211 A





ORDERING INFORMATION

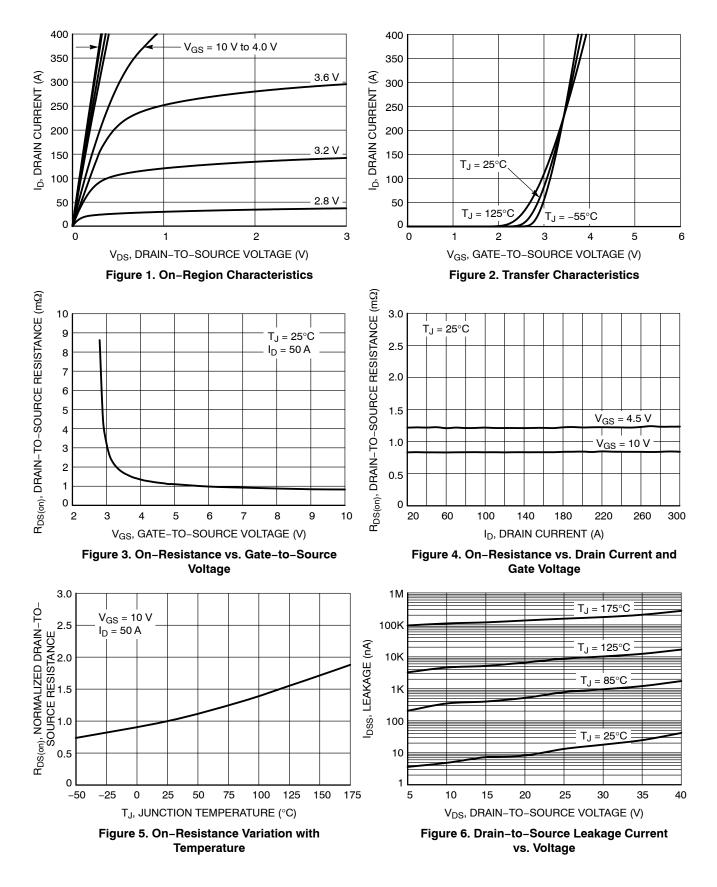
See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

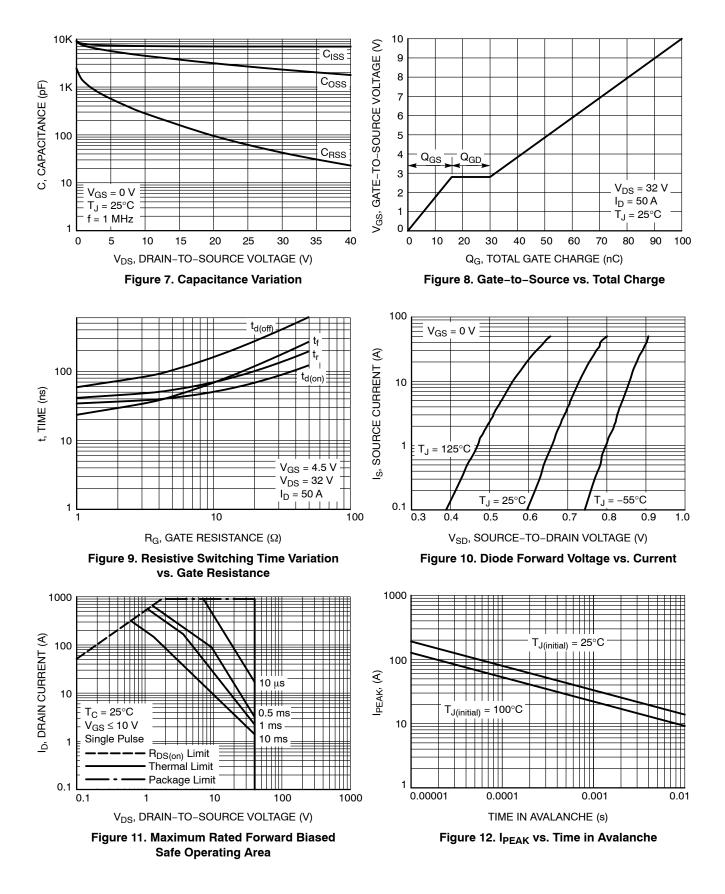
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		40			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				18.5		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$V_{GS} = 0 V,$ $T_{J} = 25^{\circ}C$			10	,	
		V _{DS} = 40 V	T _J = 125°C			100	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	_S = 20 V			100	nA	
ON CHARACTERISTICS (Note 4)							-	
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 200 μ A		1.2		2.2	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.4		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 50 A		1.2	1.4	mΩ	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.8	1.0	mΩ	
Forward Transconductance	9 _{FS}	V _{DS} = 5 V, I _D = 50 A			180		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 20 V			7020		pF	
Output Capacitance	C _{OSS}				3130			
Reverse Transfer Capacitance	C _{RSS}				95			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 32 V; I _D = 50 A			47		nC	
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 32 V; I _D = 50 A			100			
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 32 V; I _D = 50 A			8.7		nC	
Gate-to-Source Charge	Q _{GS}				16			
Gate-to-Drain Charge	Q _{GD}				14			
Plateau Voltage	V _{GP}				2.8		V	
SWITCHING CHARACTERISTICS (Note \$	5)							
Turn–On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V _{DS} = 32 V, I _D = 50 A, R _G = 2.5 Ω			37			
Rise Time	t _r				46		ns	
Turn–Off Delay Time	t _{d(OFF)}				76			
Fall Time	t _f				31			
DRAIN-SOURCE DIODE CHARACTERIS	STICS							
Forward Diode Voltage	V _{SD}	•GS – • •,	$T_J = 25^{\circ}C$		0.8	1.2		
			T _J = 125°C		0.65		V	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			75			
Charge Time	t _a				37		ns	
Discharge Time	t _b				38			
Reverse Recovery Charge	Q _{RR}				96		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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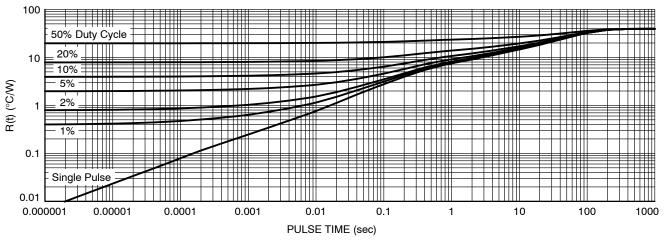


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

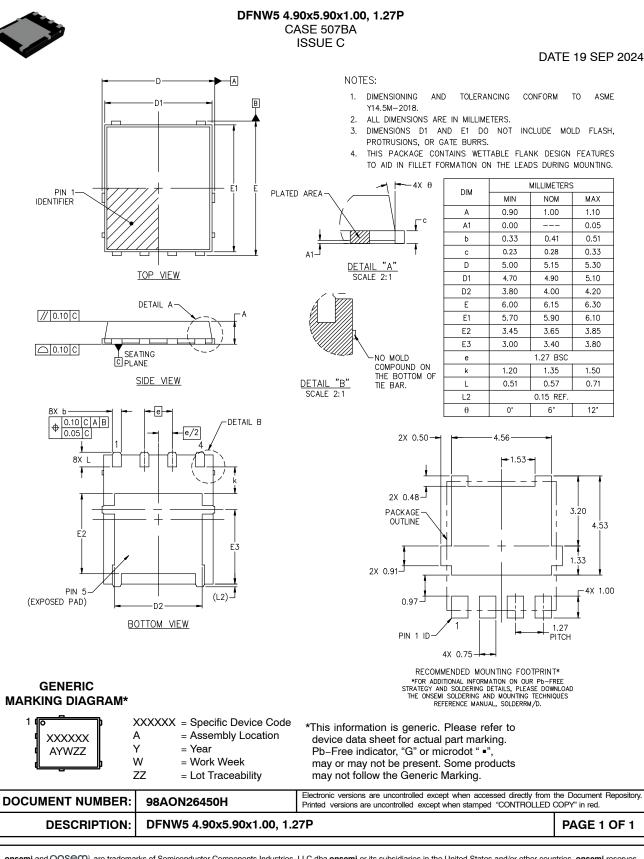
Device	Marking	Package	Shipping [†]
NVMFS5C420NLT1G	5C420L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C420NLWFT1G	420LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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